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AMENDMENT TRANSMITTAL LETTER					Docket No. M4065.0468/P468-E	
Application No. 10/649,781-Conf. #5845		Filing I August 2		Examiner S. D. Isaac	Art Uni 2812	
pplicant(s): Phi	llip E. Byrd et a	1.				
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CLAIMS AS AMENDED						
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate		
Total Claims	13	- 20 =	0	x 50.00	0.00	
Independent Claims	3	- 3 =	0	x 200.00	0.00	
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Docket No.: M4065.0468/P468-B

(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Phillip E. Byrd et al.

Application No.: 10/649,781

Confirmation No.: 5845

Filed: August 28, 2003

Art Unit: 2812

For: METHOD FOR TEMPORARILY

ISOLATING A DIE FROM A COMMON

CONDUCTOR TO

FACILITATE WAFER LEVEL TESTING

Examiner: S. D. Isaac

## AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated September 12, 2006, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Abstract begin on page 9 of this paper.

Amendments to the Claims begin on page 10 of this paper.

Remarks/Arguments begin on page 15 of this paper.